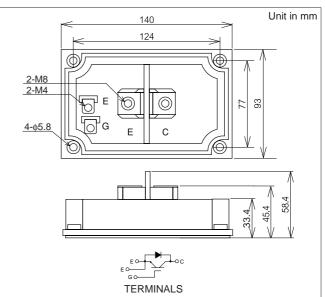
MBN600C33A

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High thermal fatigue durability. (delta Tc=70°C,N>20,000cycles)
- * low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- *High speed,low loss IGBT module.
- *Low driving power due to low input capacitance MOS gate.
- *High reliability, high durability module.
- * Isolated head sink (terminal to base).



Weight: 890 (g)

Item		Symbol	Unit	MBN600C33A		
Collector Emitter Vol	Itage	V _{CES}	V	3,300		
Gate Emitter Voltage	9	V _{GES}	V	±20		
Collector Current	DC	lc	Α	600		
	1ms	I _{CP}	A	1,200		
Forward Current	DC	lF	٨	600		
	1ms	I _{FM}	Α	1,200		
Collector Power Diss	sipation	Pc	W	5,800		
Junction Temperatur	е	Tj	°C	-40 ~ +125		
Storage Temperatur	е	T _{stg}	°C	-40 ~ +125		
Isolation Voltage		VISO	V _{RMS}	5,400(AC 1 minute)		
Screw Torque	Terminals(M4/M8)	-	N.m	2/10 (1)		
	Mounting(M5)	-		2.8 (2)		

ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

(2)Recommended Value 2.6±0.2N.m

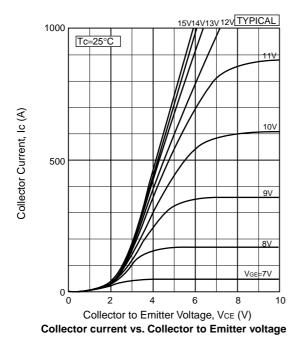
CHARACTERISTICS (Tc=25°C)

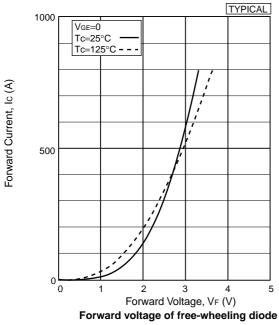
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	6.0	V _{CE} =3,300V,V _{GE} =0V
Gate Emitter Leakage Current		IGES	nA	-	-	±300	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	4.5	5.5	I _C =600A,V _{GE} =15V
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	4.0	5.5	7.0	V _{CE} =10V, I _C =600mA
Input Capacitance		Cies	nF	-	75	-	V _{CE} =10V,V _{GE} =0V,f=100KHz
Switching Times	Rise Time	tr		-	1.9	3.0	Vcc=1,650V,Ic=600A
	Turn On Time	t _{on}	μS	-	2.6	4.0	L=150nH
	Fall Time	t _f		-	2.4	3.2	$R_{G}=6.8\Omega \qquad (3)$
	Turn Off Time	t _{off}		-	4.1	6.0	V _{GE} =±15V Tc=125°C
Peak Forward Voltage Drop		V _{FM}	V	-	3.0	4.0	-Ic=600A,V _{GE} =0V
Reverse Recovery Time		t _{rr}	μS	-	0.7	1.4	Vcc=1,650V,-Ic=600A,L=150nH,
							Tc=125°C (4)
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.017	Junction to case
	FWD	Rth(j-c)		-	-	0.033	

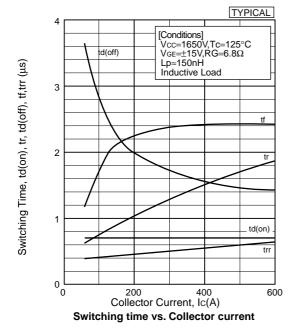
Notes:(3) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms

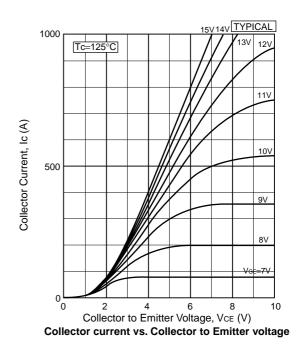
(overshoot voltage,etc.)with appliance mounted.

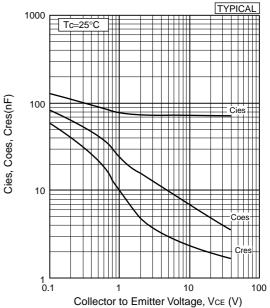
(4) Counter arm IGBT V_{GE} =-15V



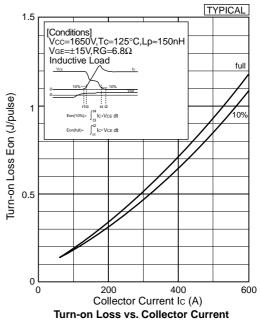




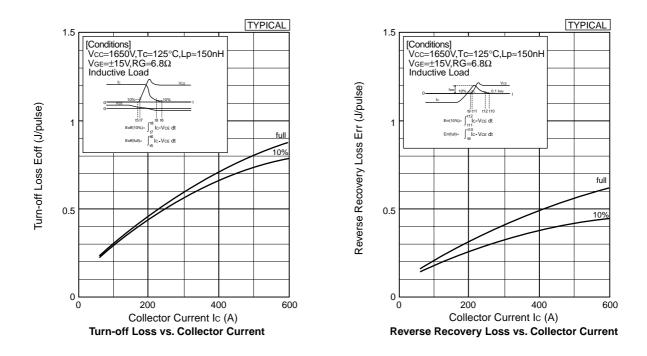




Capacitance vs. Collector to Emitter Voltage



HITACHI



HITACHI

HITACHI POWER SEMICONDUCTORS

Notices

- 1. The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are adviced to contact Hitachi sales department for the latest version of this data sheets.
- 2.Please be sure to read "Precautions for Safe Use and Notices" in the individual brochure before use.
- 3.In cases where extremely high reliability is required(such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement. Or consult Hitachi's sales department staff.
- 4.In no event shall Hitachi be liable for any damages that may result from an accident or any other cause during operation of the user's units according to this data sheets. Hitachi assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in this data sheets.
- 5.In no event shall Hitachi be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 6.No license is granted by this data sheets under any patents or other rights of any third party or Hitachi, Ltd.
- 7. This data sheets may not be reproduced or duplicated, in any form, in whole or in part, without the expressed written permission of Hitachi, Ltd.
- 8. The products (technologies) described in this data sheets are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety not are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations.

■ For inquiries relating to the products, please contact nearest overseas representatives which is located "Inquiry" portion on the top page of a home page.

HITACHI

Hitachi power semiconductor home page address http://www.hitachi.co.jp/pse